

Features

- 2835 0.7mm SMD LED
- High Brightness
- White package
- High reliability
- Water Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-P23CTUW.70.45 is a 2835 package with versatile design capabilities. It is a PLCC type LED which can be used in various applications.

Recommended Solder Pattern

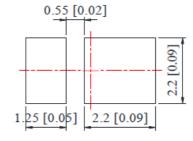
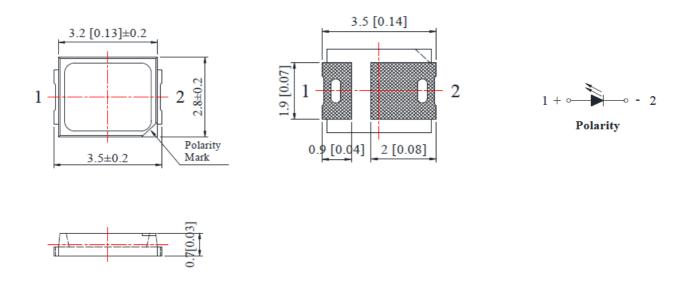


Figure 1. IN-P23CTJUW.70.45 Solder Pattern

Package Dimensions in mm



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25 mm (.010") unless otherwise noted.

Figure 2. IN-P23CTJUW.70.45 Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	T _{ST} (°C)	
IN-P23CTJUW.70.45	White	0.2	60	100	5	-40°C~+80°C	-40°C~+85°C	

Notes

- Derate linearly as shown in derating curve.
- Duty Factor = 10%, Frequency = 1 kHz

Electrical Characteristics $T_A = 25\%$ (Note 1)

Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Flux	IV	20		28	lm	IF=60mA
Viewing Angle	201/2		120		Deg	IF=60mA
Chromaticity Coordinates	Cx/Cy		0.37/0.37		-	IF=60mA
Color Temperature	ССТ	3800	4500	5000	К	IF=60mA
Color Rendering Index	CRI	70			Ra	IF=60mA
Forward Voltage	VF	2.8	3.2	3.6	V	IF=60mA
Reverse Current	I _R			10	μA	V _R =5V

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 201/2 is the o -axis angle where the luminous intensity is 1/2 the peak intensity

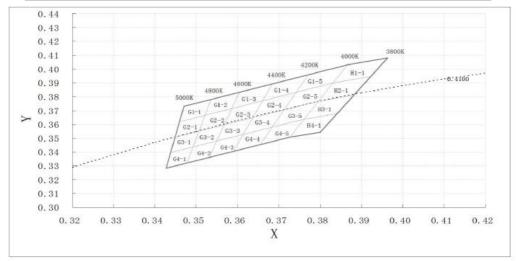
 The dominant wavelength (λd) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



Chromaticity Bin: Typ. CCT 4500K

Chromaticity Coordinates Specifications for Bin Rank:

nromaticity Coordinates Specifications for Bin Rank:											
Bin Code	Left x	Left y	Тор х	Тор у	Right x	Right y	Bottom x	Bottom y			
G1-1	0. 346	0. 362	0. 352	0. 366	0. 353	0. 378	0. 347	0. 373			
G2-1	0. 345	0. 351	0. 351	0. 356	0. 352	0. 366	0. 346	0. 362			
G3-1	0. 344	0. 340	0. 350	0. 344	0. 351	0. 356	0. 345	0. 351			
G4-1	0. 343	0. 328	0. 348	0. 332	0. 350	0. 344	0. 344	0. 340			
G1-2	0. 352	0. 366	0. 359	0. 371	0. 360	0. 383	0. 353	0. 378			
G2-2	0. 351	0. 356	0. 357	0. 359	0. 359	0. 371	0. 352	0. 366			
G3-2	0. 350	0. 344	0. 355	0. 348	0. 357	0. 359	0. 351	0. 356			
G4-2	0. 348	0. 332	0. 353	0. 336	0. 355	0. 348	0. 350	0. 344			
G1-3	0. 359	0. 371	0. 366	0. 377	0. 368	0. 389	0. 360	0. 383			
G2-3	0. 357	0. 359	0. 364	0. 365	0. 366	0. 377	0. 359	0.371			
G3-3	0. 355	0. 348	0. 361	0. 352	0. 364	0. 365	0. 357	0. 359			
G4-3	0. 353	0. 336	0. 359	0. 340	0. 361	0. 352	0. 355	0. 348			
G1-4	0. 366	0. 377	0. 374	0. 383	0. 377	0. 396	0. 368	0.389			
G2-4	0. 364	0. 365	0. 371	0. 370	0. 374	0. 383	0. 366	0.377			
G3-4	0. 361	0. 352	0. 368	0. 357	0. 371	0. 370	0. 364	0. 365			
G4-4	0. 359	0. 340	0. 365	0. 345	0. 368	0. 357	0. 361	0.352			
G1-5	0.374	0. 383	0. 384	0. 390	0. 387	0. 403	0. 377	0.396			
G2-5	0. 371	0. 370	0. 380	0. 377	0. 384	0. 390	0. 374	0.383			
G3-5	0. 368	0. 357	0. 376	0. 363	0. 380	0. 377	0. 371	0.370			
G4-5	0. 365	0. 345	0. 373	0. 351	0. 376	0. 363	0. 368	0. 357			
H1-1	0. 383	0. 390	0. 392	0. 394	0. 396	0. 408	0. 387	0. 403			
H2-1	0. 380	0. 377	0. 388	0. 381	0. 392	0. 394	0. 383	0. 390			
H3-1	0. 376	0. 363	0. 384	0. 367	0. 388	0. 381	0. 380	0. 377			
H4-1	0. 373	0. 351	0. 380	0. 354	0. 384	0. 367	0. 376	0. 363			



ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



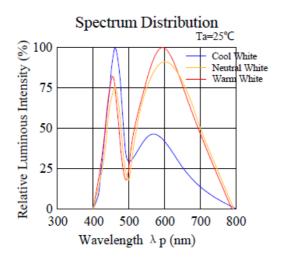
The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

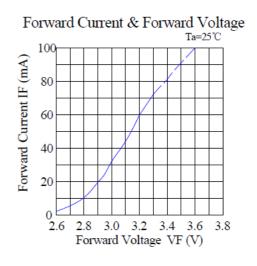
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

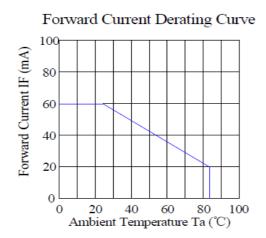
Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

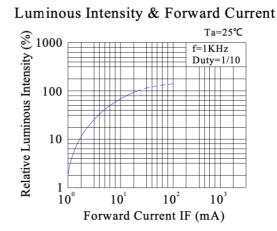


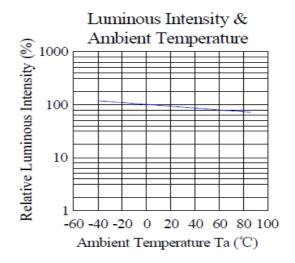
Typical Characteristic Curves





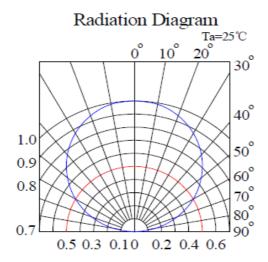








Typical Characteristic Curves – Radiation Pattern

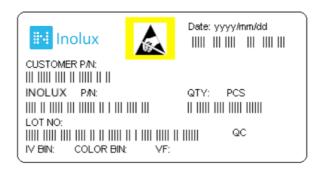


Ordering Information

Product	Emission Color	Test Current I _F (mA)	Luminous Flux I _V (lm) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-P23CTJUW.70.45	White	60	22	3.2	IN-P23CTJUW.70.45



Label Specifications



Inolux P/N:

I	N	-	Р	2	3	С	Т	J	U	W	•	70	45	-	x x x x
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color		CRI	ССТ		Customized Stamp-off
	blux MD		P = PLCC Type	230	=PLCC2	2 2835 Slug	T = Top Mount	J=60mA	U = Diffused	W= White		70=CRI 70	45=4500K		

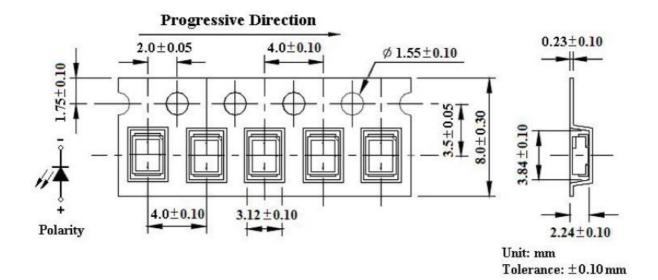
Lot No.:

Z	2	0	1	8	01	24	001
Internal		Voor (2019	2010 \	Month	Data	Sorial	
Tracker		1691 (2019	, 2019,)	WOITH	Date	Serial	

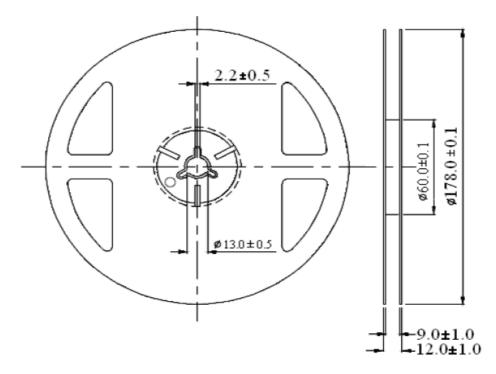


Packaging Information: 4000pcs Per Reel

Tape Dimension



Reel Dimension

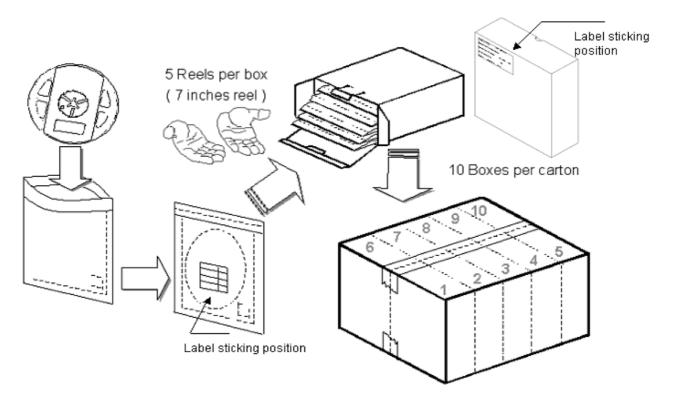


Unit: mm

Tolerance: ± 0.25 mm



Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
0.1	·		·

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

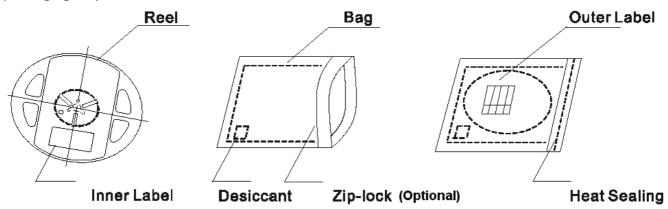


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

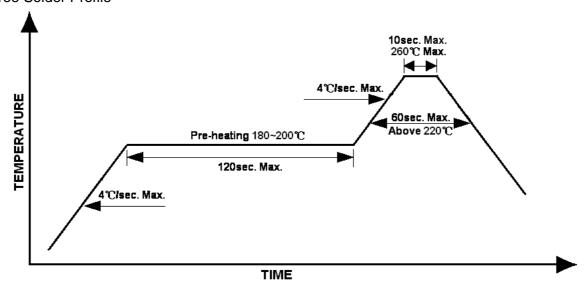
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- · Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- · Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



IN-P23CTJUW.70.45 Top View SMD LED 2835 PLCC Type

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	04-02-2020

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